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Product Specifications Approval Sheet

Pro	oduct Name: TC>	(O SMD 2.0x1.6 48	.0MHz		
TS	T Part No.: TX08	50AA2554			
Cu	stomer Part No.:				
	Company:				
	Division:				
	Approved by:				
	Date:				
L					
Ch	ecked by:	Glen Peng	Glen		
Checked by: Glen Peng Glen Approved by: Kelly Huang					
Da	ite:	02/17/2023			

- 1. Customer signed back is required before TST can proceed with sample build and receive orders.
- 2. Orders received without customer signed back will be regarded as agreement on the specifications.
- 3. Any specifications changes must be approved upon by both parties and a new revision of specifications shall be released to reflect the changes.



MODEL NO.: TX0850AA2554 REV. NO.: 2.0

Revise:

Rev.	Rev. Page	Rev. Account	Date	Ref. No.	Revised by
1	N/A	Initial release	10/22/20°	N/A	Glen Peng
1 2		Initial release Update Recommended Circuit	10/22/20° 02/17/23°	N/A ECN-202200578	



TAI-SAW TECHNOLOGY CO., LTD.

TCXO SMD 2.0x1.6 48.0MHz

MODEL NO.: TX0850AA2554 REV. NO.: 2.0

Features:

- Ultra Miniature SMD Package
- Good Frequency Stability
- Good Phase Noise Response
- Moisture Sensitivity Level (MSL): Level-1
- AEC-Q200 compliance



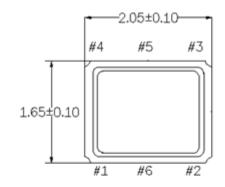
Description and Applications:

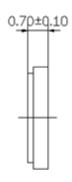
Surface mount 2.0mmx1.6mm TCXO for use in wireless communications devices

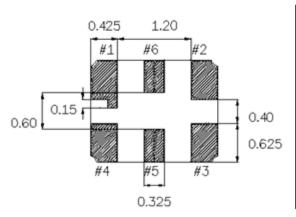
Electrical Specifications:

TX0850AA2554		Specifications				
Nominal Frequency	, Fo	48.0 MHz				
Storage Temperatu	re Range	-40°C to +105°C				
Operating Tempera	ture Range	-40°C to +105°C				
Power Supply Volta	age, Vcc	1.7~3.6 V (Nominal to 2.8V)				
Output Voltage with	Load 10pF//10KΩ, Vout	0.9~12 Vp-p				
Power Supply Curr	ent, Icc	2.0 mA max				
Frequency Tolerand	ce as received	+/- 1.0 ppm max @ 25°C +/- 3°C				
Frequency Tolerand	ce after reflow	+/- 2.0 ppm max @ 25°C +/- 3°C				
d. Vs. Supply Volta	e (-40~85°C) e (85~105°C) l 10pF//10KΩ+/-10% age varied Vcc+/-5%	+/- 2.5 ppm (reference to 25°C) +/- 7.5 ppm (reference to 25°C) +/- 0.3 ppm +/- 0.2 ppm				
. ,	of final RF level in Vp-p)	1.5 msec max.				
Aging Harmonics		+/-1.0 ppm/ first year @25°C -8.0 dBc max				
SSB Phase Noise (@1KHz Carrier Offset) (@10KHz Carrier Offset) (@100KHz Carrier Offset)		-135 dBc/Hz max -145 dBc/Hz max -150 dBc/Hz max				
Enable/Disable Fur	nction (OE function)	Pin 1: 0.8 Vcc min, Pin 3:Enable Pin 1: 0~0.2 Vcc, Pin 3 :Disable Pin 1: Do not use in open condition				
Marking		Laser marking				

Mechanical Dimensions (mm):

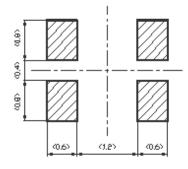






Pin	Pin Connection					
#1	0E					
#2	GND					
#3	Output					
#4	+Vcc					
#5	No connect					
#6	No connect					

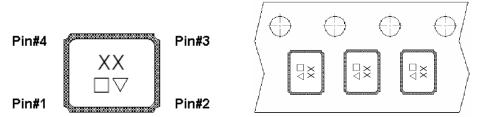
Recommended Land Pattern: (unit: mm)



Marking:

Line 1: Frequency (48)

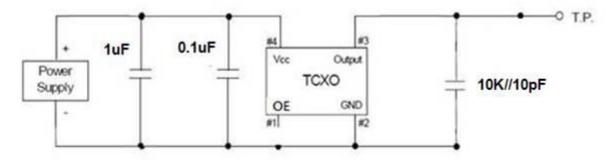
Line 2: Product Code : \square (\square is TST internal tracking code) + Date Code of Year/Month : ∇



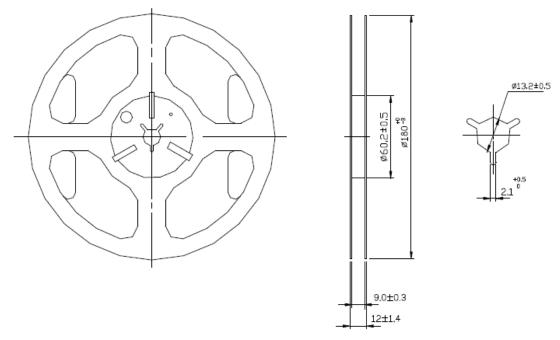
∇ : Date Code Table: Year/Month

Year/Month	1	2	თ	4	5	6	7	œ	σ	10	11	12
2020	а	þ	С	d	е	f	g	h	İ	j	k	m
2021	n	р	q	r	S	t	u	٧	W	Х	У	Z
2022	Α	В	О	D	Е	F	G	Η	J	K	١	М
2023	Ζ	Р	Q	R	S	Τ	\supset	٧	W	Х	Υ	Ζ
2024	a	þ	С	d	е	f	g	h	İ	j	k	m
2025	n	р	q	r	S	t	а	٧	W	Х	У	Z

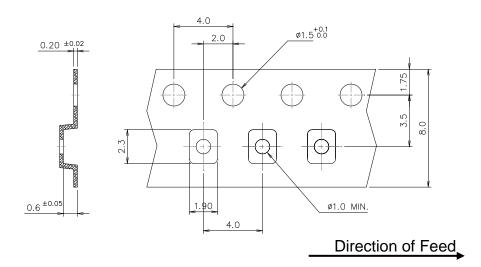
Recommended Circuit



Reel Dimension



Tape Dimensions (mm):

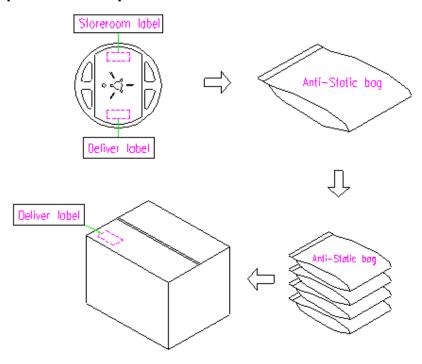


[NOTE]:

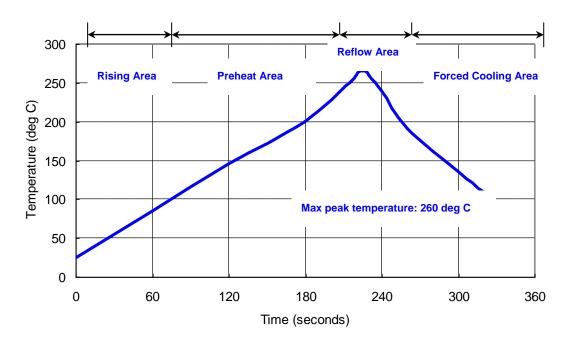
- 1. Unless otherwise specified tolerance on dimension +/-0.1 mm.
- 2. Material: conductive polystyrene with color black.
- 3. 10 pitch cumulative tolerance +/-0.2 mm.

Packing Quantity/Packing:

3K pcs maximum per reel



Reflow Profile:



Notes of the Usage:

- 1. Touch the solder iron at 260+/-5 deg C onto the leads for 10+/-2 sec max or touch the solder at 350+/-5 deg C onto the leads for 3+/-0.5 sec.
- 2. In the customer's reflow process, if it will remain some mechanical stress at the soldering terminals, also make some cracks on the soldering termination. Some cracks will cause open or short circuit and cause of thermal increasing or smoking. Don't make any excess mechanical stress to soldering points.
- 3. In case of giving a heavy shock to the products, it may make an open or short circuit and cause of thermal increasing and smoking. To avoid heavy shock impact applying to products is strictly required.
- 4. Ultrasonic cleaning should be avoided to prevent damage to the TCXO.
- Do Not Use Ultrasonic-Wave Soldering or Wave Solder with Package Immersed in Solder.

Notes of the Storage:

- 1. To keep products under the condition at the room temperature (-5~35 deg C) with normal humidity (45~75%). Absorption of moisture and dewdrop may make inferiority of characteristics and a short circuit.
- Oxidization of terminals shall make the solderability more inferior. Dusts and corrosive gas will make a cause of the open or short circuit. Keep it in the clean place where is not in dusty and no corrosive gas.
- 3. Use the unti-static material to the storage package.
- 4. Don't put any excess weight to the TCXO in the storage process.
- 5. Don't move the product from the cold place to the hot place in the short time, otherwise it may make some dew-drop, then a short circuit may happen in case.
- Storage periods should be maximum 6 months under condition of above item 1 after delivery from TST factory.
- 7. Once open the bag, there is possibility of electrical characteristics deterioration due to absorption of moisture. So, please use parts within 7 days after opening the bag.
- 8. If you have to keep parts without using after opening the bag, please put the drying agent in the bag, fold the bag and keep it in the place where temperature and humidity are controlled (nitrogen atmosphere box etc.)

Reliability Specifications

Renability Specifications								
Test name	Reference standard							
Mechanical characteristics								
resistance to Soldering heat (IR reflow)	Temp./ Duration : 265°C /10sec ×2 times Total time : 4min.(IR-reflow)	EIAJED-4701 -300(301)M(II)						
(
Vibration	Total peak amplitude : 1.5mm Vibration frequency : 10 to 2000 Hz Sweep period : 20 minute Vibration directions : 3 mutually perpendicular Duration : 2 hr / direc.	MIL-STD 202G method 204						
Mechanical Shock	directions : 3 impacts per axis Acceleration : 3000g's, +20/-0 % Duration : 0.3 ms (total 18 shocks) Waveform : Half-sine	MIL-STD 202G method 213						
Solderability	Solder Temperature:265±5°C Duration time: 5±0.5 seconds.	J-STD-002						
Environmental 6	characteristics							
Thermal Shock	Heat cycle conditions -40 °C (30min) ←→ 85 °C (30min) * cycle time : 10 times	MIL-STD 883G method 1010.8						
Humidity test	Temperature : 85 ± 2 °C Relative humidity : 85% Duration : 96 hours	MIL-STD 202G method 103						
Dry heat (Aging test)	Temperature : 125 ± 2 °C Duration : 168 hours	MIL-STD 202G method 108A						
Cold resistance (Low Temp Storage)	Temperature : -40 ± 2 °C Duration : 96 hours	IEC 60068-2-1						